UNISONIC TECHNOLOGIES CO., LTD

7N60L **Power MOSFET**

7.4 Amps, 600Volts N-CHANNEL MOSFET

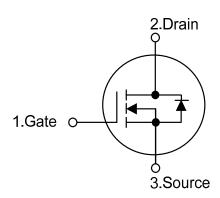
DESCRIPTION

The UTC 7N60L is a high voltage MOSFET and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in switching power supplies and adaptors.

FEATURES

- * $R_{DS(ON)}$ < 1.2 Ω @ V_{GS} = 10 V
- * Ultra low gate charge (typical 29 nC)
- * Low reverse transfer Capacitance (C_{RSS} = typical 16pF)
- * Fast switching capability
- * Avalanche energy tested
- * Improved dv/dt capability, high ruggedness

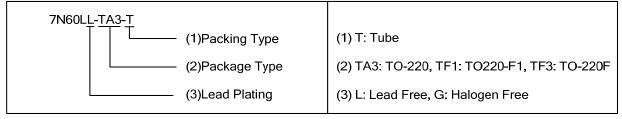
SYMBOL

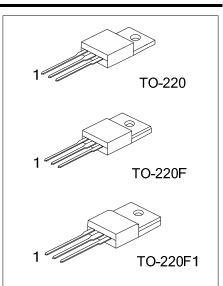


ORDERING INFORMATION

Ordering Number		Dookogo	Pin Assignment			Dooking	
Lead Free Plating	Halogen Free	Package	1	2	3	Packing	
7N60LL-x-TA3-T	7N60LG-x-TA3-T	TO-220	G	D	S	Tube	
7N60LL-x-TF1-T	7N60LG-x-TF1-T	TO-220F1	G	D	S	Tube	
7N60LL-x-TF3-T	7N60LG-x-TF3-T	TO-220F	G	D	S	Tube	

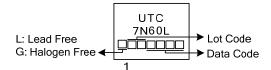
Note: Pin Assignment: G: Gate D: Drain S: Source





www.unisonic.com.tw 1 of 8

■ MARKING



■ **ABSOLUTE MAXIMUM RATINGS** (T_C = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	600	V
Gate-Source Voltage		V_{GSS}	±30	V
Avalanche Current (Note 2)		I _{AR}	7.4	Α
Continuous Drain Current		I_{D}	7.4	Α
Pulsed Drain Current (Note 1)		I _{DM}	29.6	Α
Avalanche Energy	Single Pulsed (Note 3)	E _{AS}	600	mJ
	Repetitive (Note 2)	E _{AR}	14.2	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.5	V/ns
Power Dissipation	TO-220	0	142	W
	TO-220F/TO-220F1	P_{D}	48	W
Junction Temperature		TJ	+150	°C
Storage Temperature		T _{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature
- 3. L = 22mH, I_{AS} = 7.4A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25°C
- 4. $I_{SD} \le 7.4$ A, di/dt ≤ 200 A/ μ s, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25$ °C

■ THERMAL DATA

PARAMETER		SYMBOL RATINGS		UNIT
Junction to Ambient	TO-220	0	62.5	°C/W
	TO-220F/TO-220F1	θ_{JA}	62.5	°C/W
Junction to Case	TO-220	0	0.88	°C/W
	TO-220F/TO-220F1	$\theta_{ extsf{JC}}$	2.6	°C/W

■ **ELECTRICAL CHARACTERISTICS** (T_C =25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV _{DSS}	$V_{GS} = 0V, I_D = 250\mu A$	600			V
Drain-Source Leakage Current		I _{DSS}	$V_{DS} = 600V, V_{GS} = 0V$			1	μΑ
Gate- Source Leakage Current	Forward		$V_{GS} = 30V, V_{DS} = 0V$			100	nA
	Reverse	I _{GSS}	$V_{GS} = -30V, V_{DS} = 0V$			-100	nA
Breakdown Voltage Temperature Coefficient		△BV _{DSS} /△T _J	I _D = 250μA, Referenced to 25°C		0.67		V/°C
ON CHARACTERISTICS							
Gate Threshold Voltage		V _{GS(TH)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.0		4.0	V
Static Drain-Source On-State Re	Static Drain-Source On-State Resistance		$V_{GS} = 10V, I_D = 3.7A$			1.2	Ω
DYNAMIC CHARACTERISTICS	}	R _{DS(ON)}					
Input Capacitance	nput Capacitance					1400	pF
Output Capacitance		C _{ISS}	V _{DS} =25V, V _{GS} =0V, f=1.0 MHz			180	pF
Reverse Transfer Capacitance		C_{RSS}			16	21	pF
SWITCHING CHARACTERISTIC	CS						
Turn-On Delay Time		t _{D(ON)}				70	ns
Turn-On Rise Time		t_R	$V_{DD} = 300V, I_D = 7.4A, R_G = 25\Omega$			170	ns
Turn-Off Delay Time		t _{D(OFF)}	(Note 1, 2)			140	ns
Turn-Off Fall Time		t_{F}				130	ns
Total Gate Charge		Q_{G}	-400 1 -7.44 -40\		29	38	nC
Gate-Source Charge			V _{DS} =480V, I _D =7.4A, V _{GS} =10 V (Note 1, 2)		7		nC
Gate-Drain Charge	Gate-Drain Charge		(Note 1, 2)		14.5		nC
DRAIN-SOURCE DIODE CHAR	ACTERISTI	CS AND MAXI	MUM RATINGS				
Drain-Source Diode Forward Voltage		V_{SD}	$V_{GS} = 0V, I_S = 7.4 A$			1.4	V
Maximum Continuous Drain-Source Diode		Is				7.4	Α
Forward Current						7.4	^
Maximum Pulsed Drain-Source Diode		I _{SM}				29.6	Α
Forward Current		ISM				23.0	^
Reverse Recovery Time		t_{RR}	$V_{GS} = 0V, I_S = 7.4 A,$		320		ns
Reverse Recovery Charge		Q_{RR}	dI _F / dt = 100A/μs (Note 1)		2.4		μC

Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%

^{2.} Essentially independent of operating temperature

■ TEST CIRCUITS AND WAVEFORMS

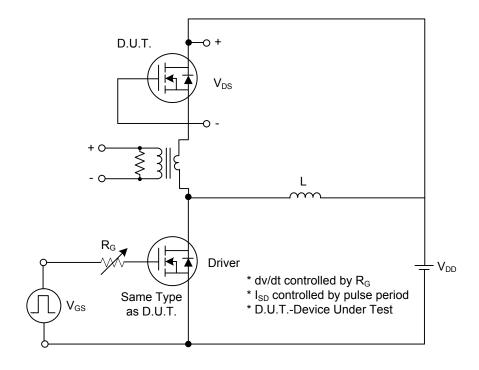


Fig. 1A Peak Diode Recovery dv/dt Test Circuit

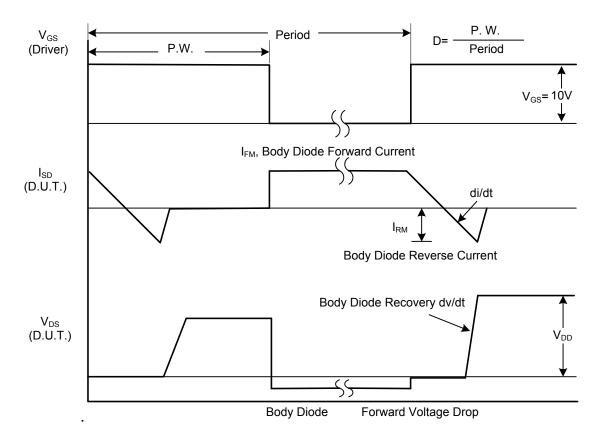
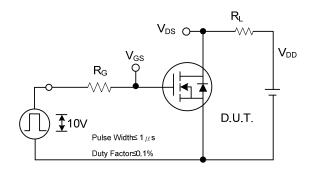


Fig. 1B Peak Diode Recovery dv/dt Waveforms

■ TEST CIRCUITS AND WAVEFORMS (Cont.)



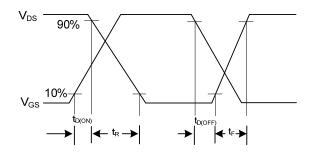
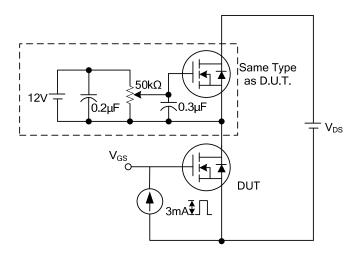


Fig. 2A Switching Test Circuit

Fig. 2B Switching Waveforms



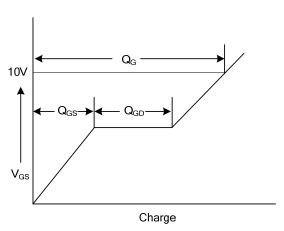
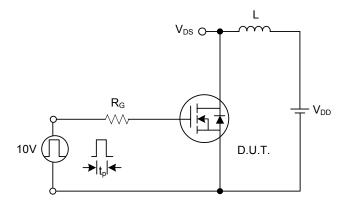


Fig. 3A Gate Charge Test Circuit

Fig. 3B Gate Charge Waveform



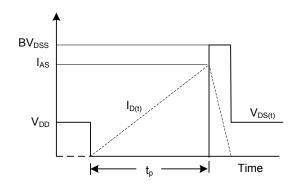
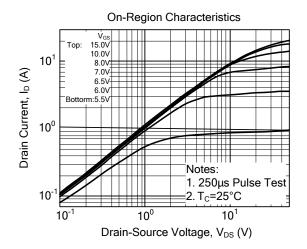
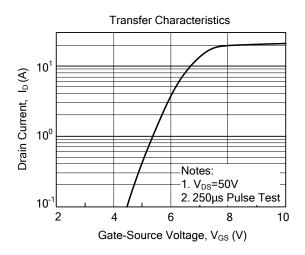


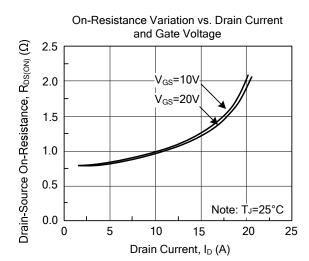
Fig. 4A Unclamped Inductive Switching Test Circuit

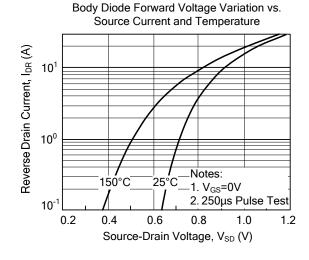
Fig. 4B Unclamped Inductive Switching Waveforms

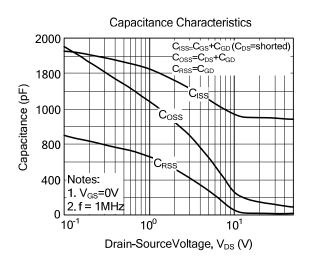
■ TYPICAL CHARACTERISTICS

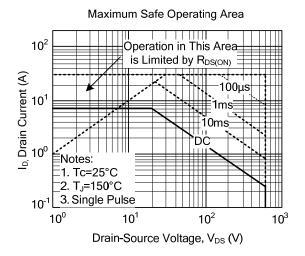












UTC assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all UTC products described or contained herein. UTC products are not designed for use in life support appliances, devices or systems where malfunction of these products can be reasonably expected to result in personal injury. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner. The information presented in this document does not form part of any quotation or contract, is believed to be accurate and reliable and may be changed without notice.